

DS2102SY

RECTIFIER DIODE

APPLICATIONS

- Rectification.
- Freewheel Diode.
- DC Motor Control.
- Power Supplies.
- Welding.
- Battery Chargers.

KEY PARAMETERS

V_{RRM}	2000V
$I_{F(AV)}$	5460A
I_{FSM}	100000A

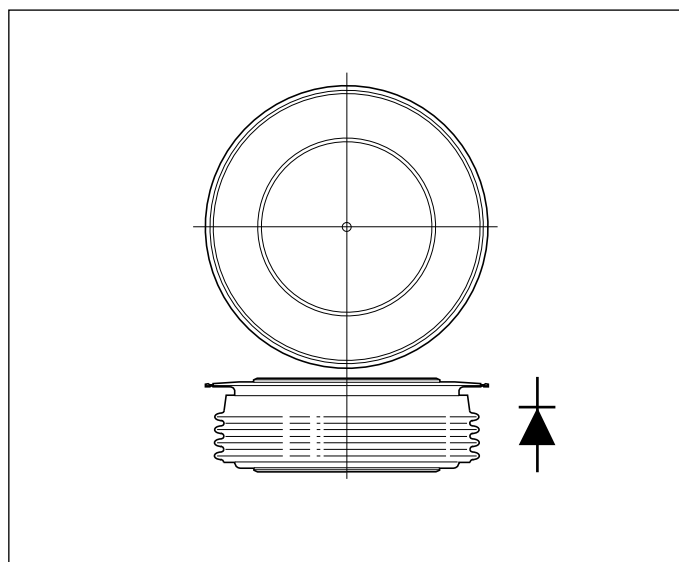
FEATURES

- Double Side Cooling.
- High Surge Capability.

VOLTAGE RATINGS

Type Number	Repetitive Peak Reverse Voltage V_{RRM} V	Conditions
DS2102SY20	2000	$V_{RSM} = V_{RRM} + 100V$
DS2102SY19	1900	
DS2102SY18	1800	
DS2102SY17	1700	
DS2102SY16	1600	
DS2102SY15	1500	

Lower voltage grades available.



Outline type code: Y. Turn to page 7 for further information.

CURRENT RATINGS

Symbol	Parameter	Conditions	Max.	Units
Double Side Cooled				
$I_{F(AV)}$	Mean forward current	Half wave resistive load, $T_{case} = 100^{\circ}C$	5460	A
$I_{F(RMS)}$	RMS value	$T_{case} = 100^{\circ}C$	8575	A
I_F	Continuous (direct) forward current	$T_{case} = 100^{\circ}C$	7450	A
Single Side Cooled (Anode side)				
$I_{F(AV)}$	Mean forward current	Half wave resistive load, $T_{case} = 100^{\circ}C$	3410	A
$I_{F(RMS)}$	RMS value	$T_{case} = 100^{\circ}C$	5356	A
I_F	Continuous (direct) forward current	$T_{case} = 100^{\circ}C$	4260	A

SURGE RATINGS

Symbol	Parameter	Conditions	Max.	Units
I_{FSM}	Surge (non-repetitive) forward current	10ms half sine; $T_{case} = 175^{\circ}C$ $V_R = 50\% V_{RRM} - 1/4$ sine	80.0	kA
I^2t	I^2t for fusing		32×10^6	A ² s
I_{FSM}	Surge (non-repetitive) forward current	10ms half sine; $T_{case} = 175^{\circ}C$ $V_R = 0$	100.0	kA
I^2t	I^2t for fusing		50×10^6	A ² s

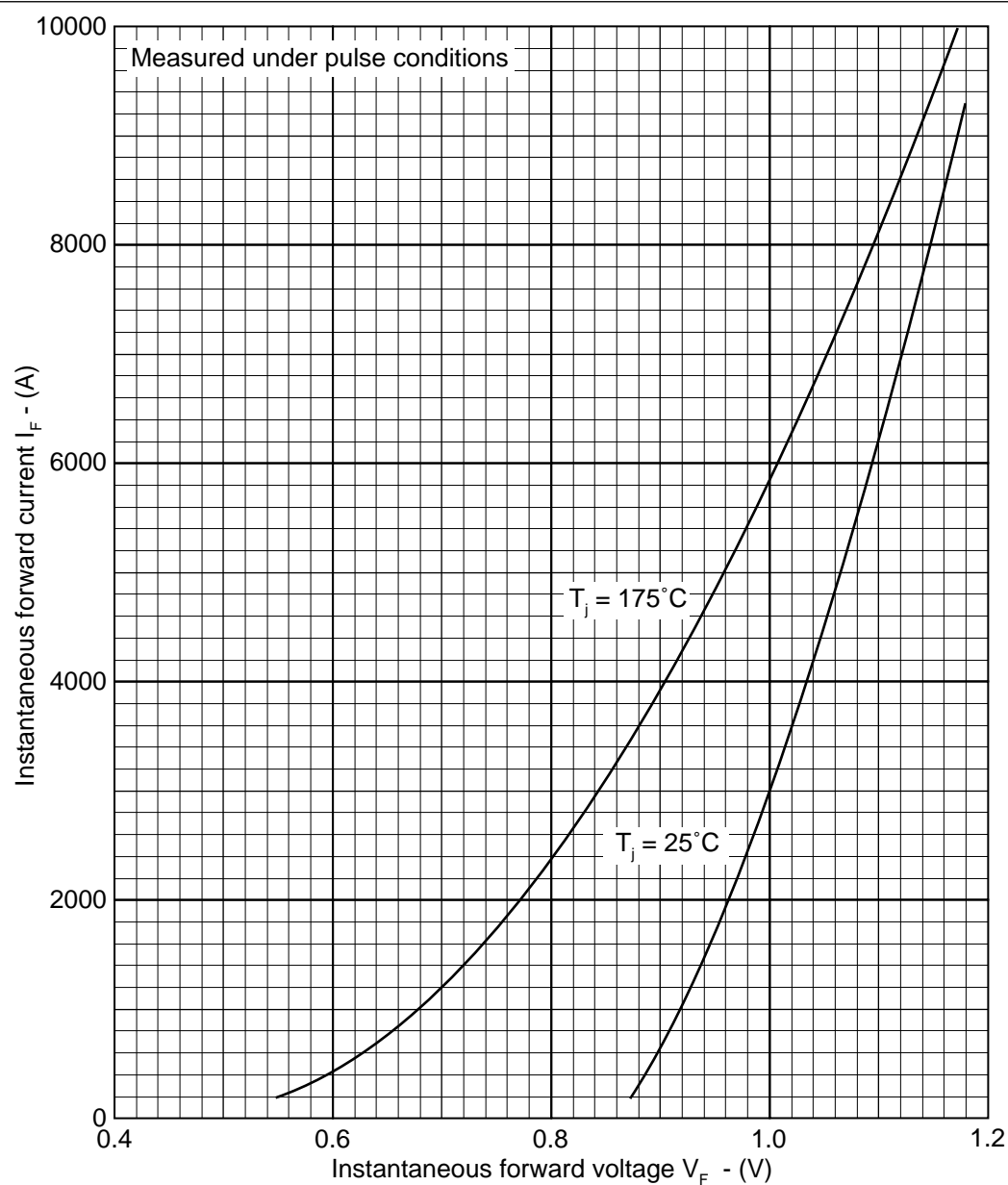
THERMAL AND MECHANICAL DATA

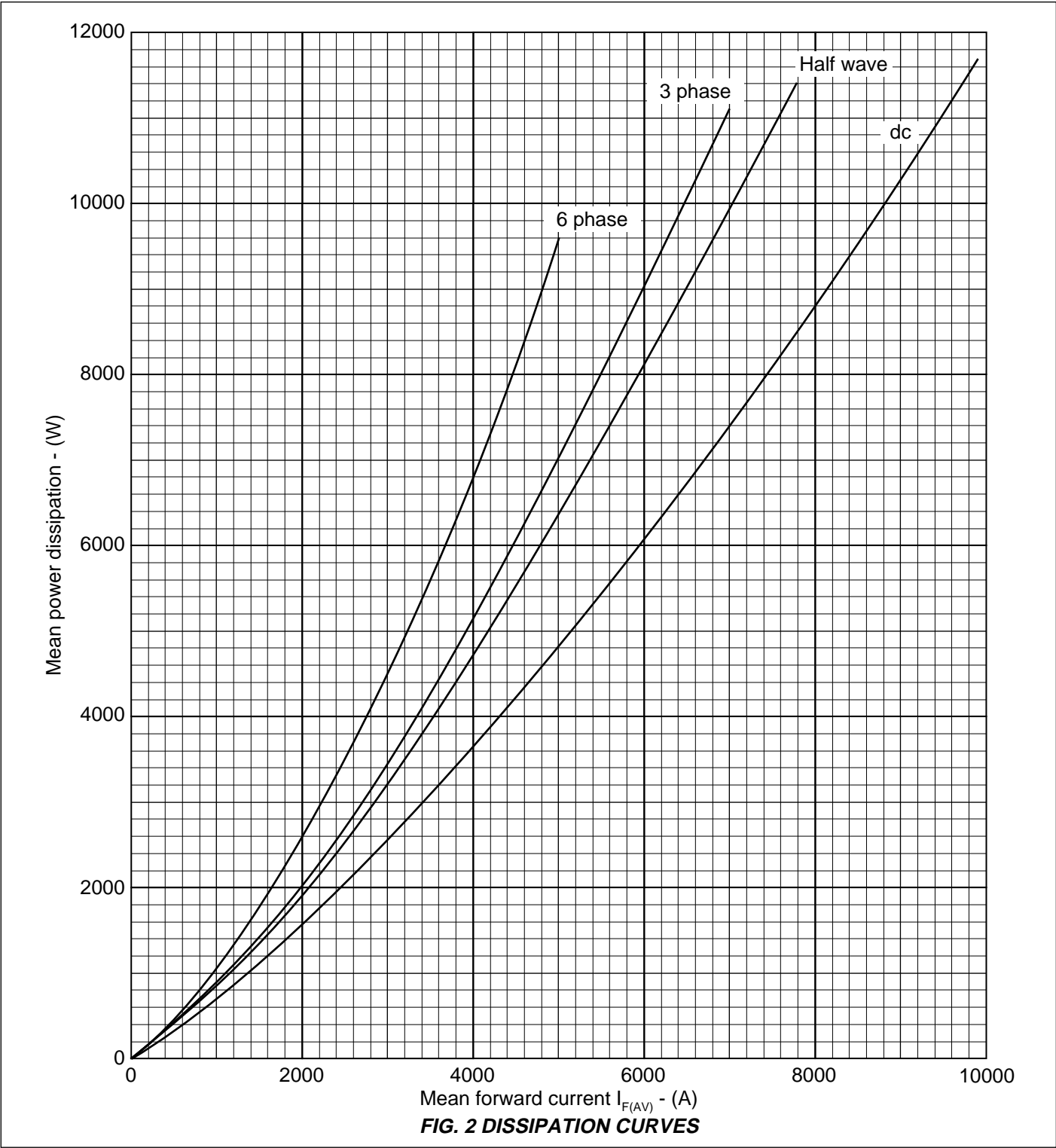
Symbol	Parameter	Conditions		Min.	Max.	Units
$R_{th(j-c)}$	Thermal resistance - junction to case	Double side cooled	dc	-	0.0095	$^{\circ}C/W$
		Single side cooled	Anode dc	-	0.019	$^{\circ}C/W$
			Cathode dc	-	0.019	$^{\circ}C/W$
$R_{th(c-h)}$	Thermal resistance - case to heatsink	Clamping force 43.0kN with mounting compound	Double side	-	0.002	$^{\circ}C/W$
			Single side	-	0.004	$^{\circ}C/W$
T_{vj}	Virtual junction temperature	Forward (conducting)		-	200	$^{\circ}C$
		Reverse (blocking)		-	175	$^{\circ}C$
T_{stg}	Storage temperature range			-55	175	$^{\circ}C$
-	Clamping force			38.0	47.0	kN

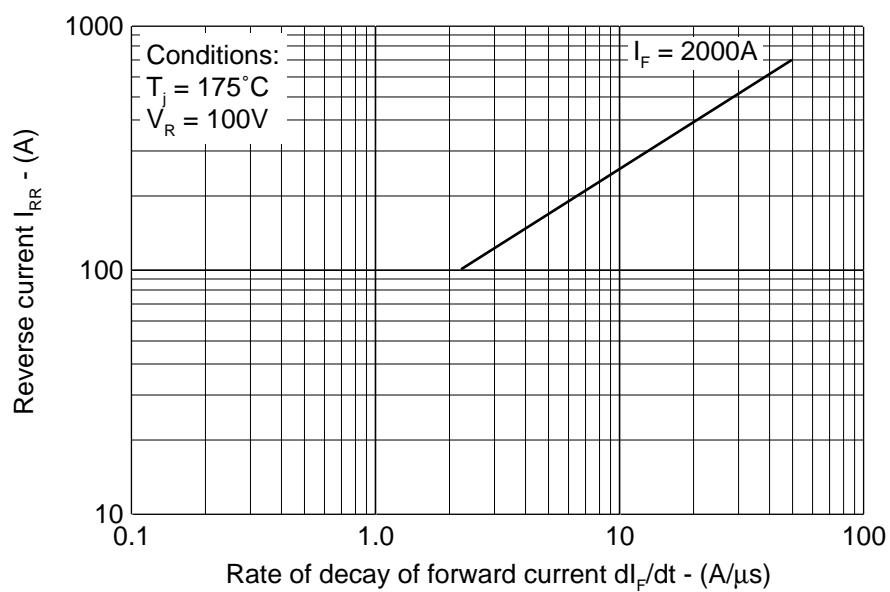
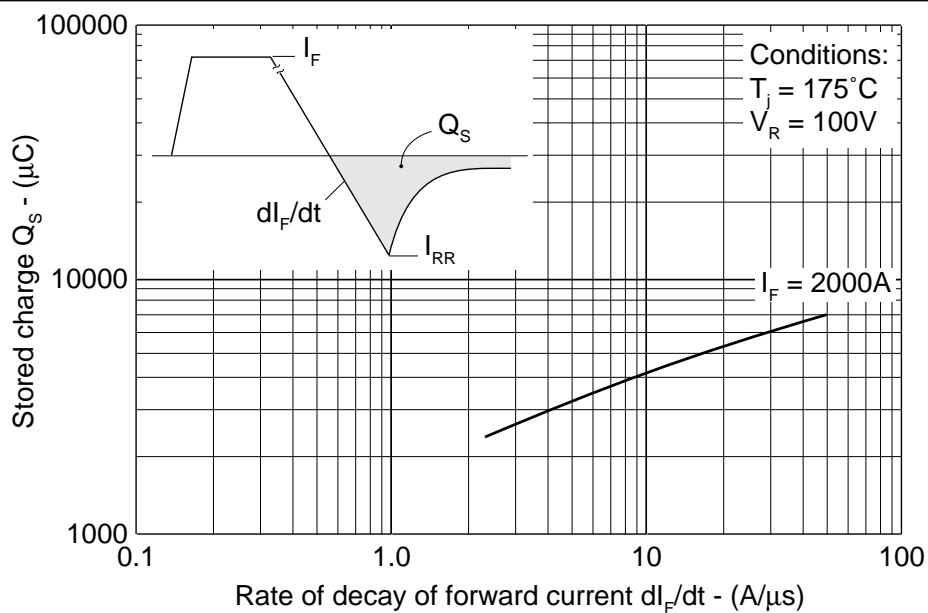
CHARACTERISTICS

Symbol	Parameter	Conditions	Min.	Max.	Units
V_{FM}	Forward voltage	At 3000A peak, $T_{case} = 25^{\circ}C$	-	1.0	V
I_{RRM}	Peak reverse current	At V_{RRM} , $T_{case} = 175^{\circ}C$	-	100	mA
Q_S	Total stored charge	$I_F = 2000A$, $di_{RR}/dt = 3A/\mu s$ $T_{case} = 175^{\circ}C$, $V_R = 100V$	-	2600	μC
I_{RR}	Peak recovery current		-	120	A
V_{TO}	Threshold voltage	At $T_{vj} = 175^{\circ}C$	-	0.75	V
r_T	Slope resistance	At $T_{vj} = 175^{\circ}C$	-	0.0415	m Ω

CURVES

**FIG. 1 MAXIMUM (LIMIT) FORWARD CHARACTERISTICS**





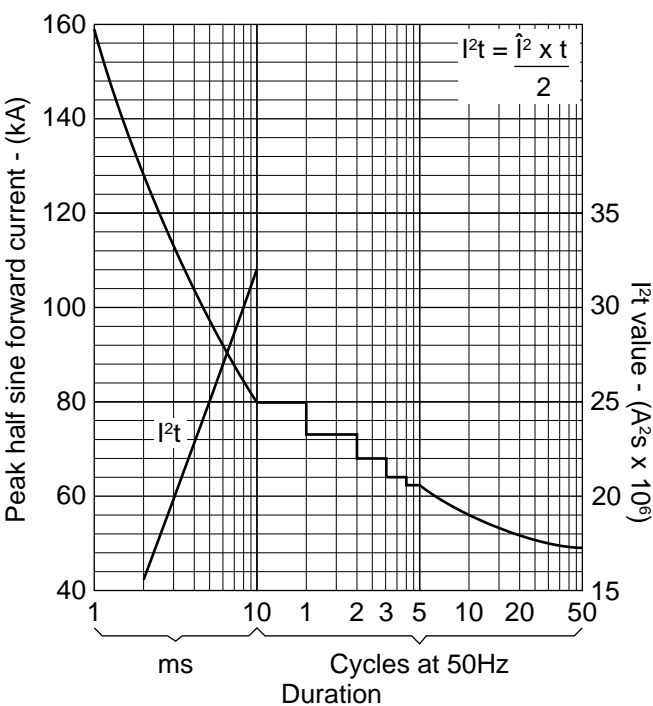


FIG. 5 SURGE (NON-REPETITIVE) FORWARD CURRENT vs TIME (WITH 50% V_{RRM} $T_{case} = 175^{\circ}C$)

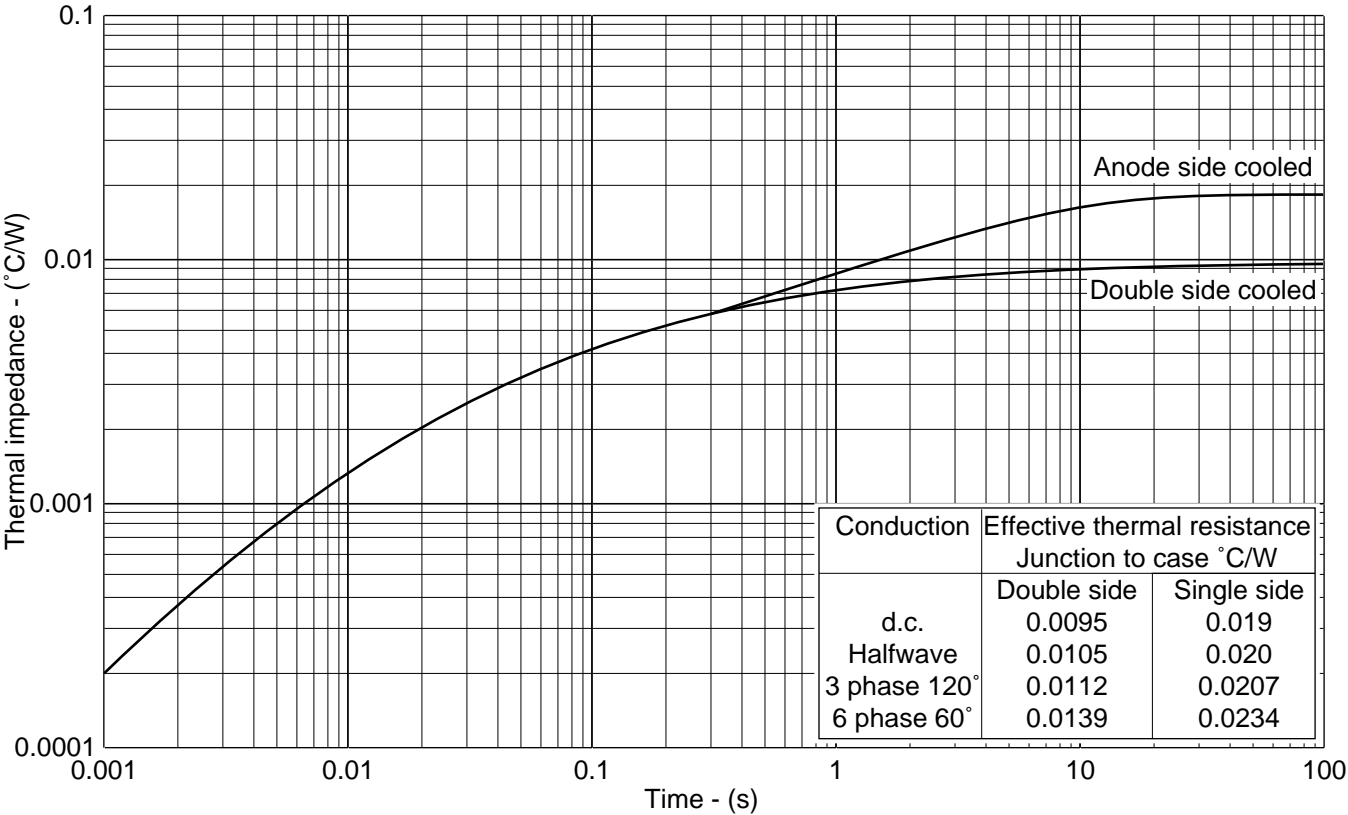
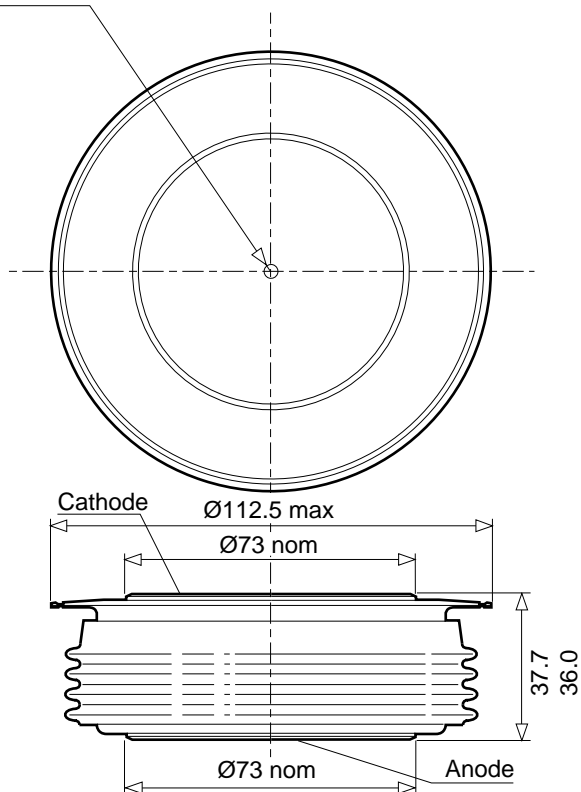


FIG. 6 MAXIMUM (LIMIT) TRANSIENT THERMAL IMPEDANCE - JUNCTION TO CASE - (°C/W)

PACKAGE DETAILS - Y

For further package information, please contact your local Customer Service Centre. All dimensions in mm, unless stated otherwise.
DO NOT SCALE.

2 holes $\varnothing 3.6 \times 2.0$ deep (One in each electrode)



Weight: 1600g



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